# Wideband Two Quadrant Analog Multiplier (Voltage Output) 

## Features

- This Circuit is Processed in Accordance to MIL-STD883 and is Fully Conformant Under the Provisions of Paragraph 1.2.1.
- High Speed Voltage Output. . . . . . . . . . . 300V/ $\mu \mathrm{s}$ (Min)
- Low Multiplication Error . . . . . . . . . . . . . . . . 3.0\% (Max) 1.6\% (Typ)
- Input Bias Currents . . . . . . . . . . . . . . . . . . . . . $5 \mu \mathrm{~A}$ (Max) $1.2 \mu \mathrm{~A}$ (Typ)
- Signal Input Feedthrough . . . . . . . . . . . . . . -52dB (Typ)
- Wide Signal Bandwidth. . . . . . . . . . . . . . 30MHz (Typ)
- Wide Control Bandwidth . . . . . . . . . . . . . 17MHz (Typ)
- Gain Flatness to 5MHz. . . . . . . . . . . . . . . . 0.10dB (Typ)


## Applications

- Military Avionics
- Missile Guidance Systems
- Medical Imaging Displays
- Video Mixers
- Sonar AGC Processors
- Radar Signal Conditioning
- Voltage Controlled Amplifier
- Vector Generator


## Description

The HA-2546/883 is a monolithic, high speed, two quadrant, analog multiplier constructed in the Intersil Dielectrically Isolated High Frequency Process. The HA-2546/883 has a voltage output with a 30 MHz signal bandwidth, $300 \mathrm{~V} / \mu$ s slew rate and a 17 MHz control input bandwidth. High bandwidth and slew rate make this part an ideal component for use in video systems. The suitability for precision video applications is demonstrated further by the 0.1 dB gain flatness at $5 \mathrm{MHz}, 1.6 \%$ multiplication error, -52dB feedthrough and differential inputs with $1.2 \mu \mathrm{~A}$ bias currents. The HA-2546/883 also has low differential gain (0.1\% typ.) and phase (0.10 typ.) errors.

The HA-2546/883 is well suited for AGC circuits as well as mixer applications for sonar, radar, and medical imaging equipment. The voltage output of the HA-2546/883 simplifies many designs by eliminating the current-to-voltage conversion stage required for current output multipliers.

## Ordering Information

| PART NUMBER | TEMPERATURE <br> RANGE | PACKAGE |
| :--- | :--- | :--- |
| HA1-2546/883 | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 16 Lead CerDIP |
| HA4-2546/883 | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 20 Lead Ceramic LCC |

## Pinouts

HA-2546/883
(CERDIP)
TOP VIEW


HA-2546/883
(CLCC)
TOP VIEW


| Absolute Maximum Ratings |  |
| :---: | :---: |
| Voltage Between V+ and V- | 35 V |
| Differential Input Voltage | 6V |
| Output Current | 60 mA |
| Junction Temperature. | $+175^{\circ} \mathrm{C}$ |
| Storage Temperature Range | $-65^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+150^{\circ} \mathrm{C}$ |
| ESD Rating. | <2000V |
| Lead Temperature (Soldering 10s) | $+300^{\circ} \mathrm{C}$ |

## Absolute Maximum Ratings

## Thermal Information

| Thermal Resistance | $\theta_{\text {JA }}$ | $\theta_{\text {Jc }}$ |
| :---: | :---: | :---: |
| CerDIP Package | $80^{\circ} \mathrm{C} / \mathrm{W}$ | $25^{\circ} \mathrm{C} / \mathrm{W}$ |
| Ceramic LCC. | $61^{\circ} \mathrm{C} / \mathrm{W}$ | $12^{\circ} \mathrm{C} / \mathrm{W}$ |
| Maximum Package Power Dissipation |  |  |
| CerDIP Package at $+75^{\circ} \mathrm{C}$. |  | 1.25W |
| Ceramic LCC Package at $+75^{\circ} \mathrm{C}$. |  | 64W |
| Package Power Dissipation Derating Factor above $+75^{\circ} \mathrm{C}$ |  |  |
| CerDIP Package |  | $12 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ |
| Ceramic LCC Package |  | $16 \mathrm{~mW} /{ }^{\circ}$ |

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

## Operating Conditions

Operating Temperature Range
$-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ Operating Supply Voltage
$\pm 8 \mathrm{~V}$ to $\pm 15 \mathrm{~V}$
TABLE 1. DC ELECTRICAL PERFORMANCE CHARACTERISTICS
Device Tested at: $V_{\text {SUPPLY }}= \pm 15 \mathrm{~V}, \mathrm{R}_{\text {LOAD }}=1 \mathrm{k} \Omega, \mathrm{C}_{\text {LOAD }}=50 \mathrm{pF}$, Unless Otherwise Specified.

| PARAMETERS | SYMBOL | CONDITIONS | $\qquad$ | TEMPERATURE | LIMITS |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  | MIN | MAX |  |
| Multiplication Error | ME | $\mathrm{V}_{\mathrm{Y}}= \pm 5 \mathrm{~V}$ | 1 | $+25^{\circ} \mathrm{C}$ | -3 | 3 | \%FS |
|  |  |  | 2, 3 | $+125^{\circ} \mathrm{C},-55^{\circ} \mathrm{C}$ | -5 | 5 | \%FS |
| Scale Factor Error | SF |  | 1 | $+25^{\circ} \mathrm{C}$ | -5 | 5 | \% |
|  |  |  | 2, 3 | $+125^{\circ} \mathrm{C},-55^{\circ} \mathrm{C}$ | -5 | 5 | \% |
| Common Mode Range | +CMR |  | 1 | $+25^{\circ} \mathrm{C}$ | 5 | - | V |
|  |  |  | 2, 3 | $+125^{\circ} \mathrm{C},-55^{\circ} \mathrm{C}$ | 5 | - | V |
|  | -CMR |  | 1 | $+25^{\circ} \mathrm{C}$ | - | -5 | V |
|  |  |  | 2, 3 | $+125^{\circ} \mathrm{C},-55^{\circ} \mathrm{C}$ | - | -5 | V |
| Input Offset Voltage ( $\mathrm{V}_{\mathrm{Y}}$ ) | $\mathrm{V}_{10}\left(\mathrm{~V}_{\mathrm{Y}}\right)$ | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | 1 | $+25^{\circ} \mathrm{C}$ | -10 | 10 | mV |
|  |  |  | 2, 3 | $+125^{\circ} \mathrm{C},-55^{\circ} \mathrm{C}$ | -15 | 15 | mV |
| Input Bias Current ( $\mathrm{V}_{\mathrm{Y}}$ ) | $\mathrm{I}_{\mathrm{B}}\left(\mathrm{V}_{\mathrm{Y}}\right)$ | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | 1 | $+25^{\circ} \mathrm{C}$ | -15 | 15 | $\mu \mathrm{A}$ |
|  |  |  | 2, 3 | $+125^{\circ} \mathrm{C},-55^{\circ} \mathrm{C}$ | -20 | 20 | $\mu \mathrm{A}$ |
| Input Offset Current ( $\mathrm{V}_{\mathrm{Y}}$ ) | $\mathrm{I}_{10}\left(\mathrm{~V}_{Y}\right)$ | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | 1 | $+25^{\circ} \mathrm{C}$ | -2 | 2 | $\mu \mathrm{A}$ |
|  |  |  | 2, 3 | $+125^{\circ} \mathrm{C},-55^{\circ} \mathrm{C}$ | -3 | 3 | $\mu \mathrm{A}$ |
| Common Mode ( $\mathrm{V}_{\mathrm{Y}}$ ) Rejection Ratio | $+\mathrm{CMRR}\left(\mathrm{V}_{\mathrm{Y}}\right)$ | $\mathrm{V}_{\mathrm{Y}}=0$ to $+5 \mathrm{~V}, \mathrm{~V}_{\mathrm{X}}=+2 \mathrm{~V}$ | 1 | $+25^{\circ} \mathrm{C}$ | 60 | - | dB |
|  |  |  | 2, 3 | $+125^{\circ} \mathrm{C},-55^{\circ} \mathrm{C}$ | 60 | - | dB |
|  | - $\operatorname{CMRR}\left(\mathrm{V}_{\mathrm{Y}}\right)$ | $\mathrm{V}_{\mathrm{Y}}=0$ to $-5 \mathrm{~V}, \mathrm{~V}_{\mathrm{X}}=+2 \mathrm{~V}$ | 1 | $+25^{\circ} \mathrm{C}$ | 60 | - | dB |
|  |  |  | 2, 3 | $+125^{\circ} \mathrm{C},-55^{\circ} \mathrm{C}$ | 60 | - | dB |
| Input Offset Voltage ( $\mathrm{V}_{\mathrm{X}}$ ) | $\mathrm{V}_{10}\left(\mathrm{~V}_{\mathrm{X}}\right)$ | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | 1 | $+25^{\circ} \mathrm{C}$ | -2 | 2 | mV |
|  |  |  | 2, 3 | $+125^{\circ} \mathrm{C},-55^{\circ} \mathrm{C}$ | -15 | 15 | mV |
| Input Bias Current ( $\mathrm{V}_{\mathrm{X}}$ ) | $\mathrm{I}_{\mathrm{B}}\left(\mathrm{V}_{\mathrm{X}}\right)$ | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | 1 | $+25^{\circ} \mathrm{C}$ | -2 | 2 | $\mu \mathrm{A}$ |
|  |  |  | 2, 3 | $+125^{\circ} \mathrm{C},-55^{\circ} \mathrm{C}$ | -5 | 5 | $\mu \mathrm{A}$ |
| Input Offset Current ( $\mathrm{V}_{\mathrm{X}}$ ) | $\mathrm{I}_{10}\left(\mathrm{~V}_{\mathrm{x}}\right)$ | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ | 1 | $+25^{\circ} \mathrm{C}$ | -2 | 2 | $\mu \mathrm{A}$ |
|  |  |  | 2, 3 | $+125^{\circ} \mathrm{C},-55^{\circ} \mathrm{C}$ | -3 | 3 | $\mu \mathrm{A}$ |
| Input Offset Voltage ( $\mathrm{V}_{\mathrm{Z}}$ ) | $\mathrm{V}_{10}\left(\mathrm{~V}_{\mathrm{Z}}\right)$ | $\mathrm{V}_{\mathrm{X}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{Y}}=0 \mathrm{~V}$ | 1 | $+25^{\circ} \mathrm{C}$ | -15 | 15 | mV |
|  |  |  | 2, 3 | $+125^{\circ} \mathrm{C},-55^{\circ} \mathrm{C}$ | -15 | 15 | mV |
| Output Voltage Swing | $+\mathrm{V}_{\text {OUT }}$ | $\mathrm{V}_{\mathrm{Y}}=+5 \mathrm{~V}, \mathrm{~V}_{\mathrm{X}}=+2.5 \mathrm{~V}$ | 1 | $+25^{\circ} \mathrm{C}$ | 5 | - | V |
|  |  |  | 2, 3 | $+125^{\circ} \mathrm{C},-55^{\circ} \mathrm{C}$ | 5 | - | V |
|  | - $\mathrm{V}_{\text {OUT }}$ | $V_{Y}=-5 \mathrm{~V}, \mathrm{~V}_{\mathrm{X}}=+2.5 \mathrm{~V}$ | 1 | $+25^{\circ} \mathrm{C}$ | - | -5 | V |
|  |  |  | 2, 3 | $+125^{\circ} \mathrm{C},-55^{\circ} \mathrm{C}$ | - | -5 | V |
| Output Current | ${ }^{\text {l }}$ OUT | $\mathrm{V}_{\mathrm{Y}}=+5 \mathrm{~V}, \mathrm{~V}_{\mathrm{X}}=+2.5 \mathrm{~V}$ | 1 | $+25^{\circ} \mathrm{C}$ | 20 | - | mA |
|  |  |  | 2, 3 | $+125^{\circ} \mathrm{C},-55^{\circ} \mathrm{C}$ | 20 | - | mA |
|  | - ${ }^{\text {OUT }}$ | $\mathrm{V}_{\mathrm{Y}}=-5 \mathrm{~V}, \mathrm{~V}_{\mathrm{X}}=+2.5 \mathrm{~V}$ | 1 | $+25^{\circ} \mathrm{C}$ | - | -20 | mA |
|  |  |  | 2, 3 | $+125^{\circ} \mathrm{C},-55^{\circ} \mathrm{C}$ | - | -20 | mA |

Specifications HA2546/883

TABLE 1. DC ELECTRICAL PERFORMANCE CHARACTERISTICS (Continued)
Device Tested at: $V_{\text {SUPPLY }}= \pm 15 \mathrm{~V}, R_{\text {LOAD }}=1 \mathrm{k} \Omega, \mathrm{C}_{\text {LOAD }}=50 \mathrm{pF}$, Unless Otherwise Specified.

| PARAMETERS | SYMBOL | CONDITIONS | GROUP ASUBGROUPS | TEMPERATURE | LIMITS |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  | MIN | MAX |  |
| Power Supply Rejection Ratio | +PSRR | $\begin{aligned} & \Delta \mathrm{V}_{S}=3 \mathrm{~V}, \mathrm{~V}+=+15 \mathrm{~V}, \mathrm{~V}-=-15 \mathrm{~V}, \\ & \mathrm{~V}+=+12 \mathrm{~V}, \mathrm{~V}-=-15 \mathrm{~V} \end{aligned}$ | 1 | $+25^{\circ} \mathrm{C}$ | 58 | - | dB |
|  |  |  | 2, 3 | $+125^{\circ} \mathrm{C},-55^{\circ} \mathrm{C}$ | 58 | - | dB |
|  | -PSRR | $\begin{aligned} & \Delta \mathrm{V}_{\mathrm{S}}=3 \mathrm{~V}, \mathrm{~V}+=+15 \mathrm{~V}, \mathrm{~V}-=-15 \mathrm{~V}, \\ & \mathrm{~V}+=+15 \mathrm{~V}, \mathrm{~V}-=-12 \mathrm{~V} \end{aligned}$ | 1 | $+25^{\circ} \mathrm{C}$ | 58 | - | dB |
|  |  |  | 2, 3 | $+125^{\circ} \mathrm{C},-55^{\circ} \mathrm{C}$ | 58 | - | dB |
| Quiescent Power Supply Current | ${ }^{+1} \mathrm{CC}$ | $\mathrm{V}_{\mathrm{X}}=\mathrm{V}_{\mathrm{Y}}=0 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=0 \mathrm{~mA}$ | 1 | $+25^{\circ} \mathrm{C}$ | 29 | - | mA |
|  |  |  | 2, 3 | $+125^{\circ} \mathrm{C},-55^{\circ} \mathrm{C}$ | 29 | - | mA |
|  | ${ }^{-1} \mathrm{CC}$ | $\mathrm{V}_{\mathrm{X}}=\mathrm{V}_{\mathrm{Y}}=0 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=0 \mathrm{~mA}$ | 1 | $+25^{\circ} \mathrm{C}$ | - | -29 | mA |
|  |  |  | 2, 3 | $+125^{\circ} \mathrm{C},-55^{\circ} \mathrm{C}$ | - | -29 | mA |

TABLE 2. AC ELECTRICAL PERFORMANCE CHARACTERISTICS
Table 2 Intentionally Left Blank. See AC Specifications in Table 3.

TABLE 3. ELECTRICAL PERFORMANCE CHARACTERISTICS
Device Tested at: $V_{\text {SUPPLY }}= \pm 15 \mathrm{~V}, R_{\text {LOAD }}=1 \mathrm{k} \Omega, C_{\text {LOAD }}=50 \mathrm{pF}$, Unless Otherwise Specified.

| PARAMETER | SYMBOL | CONDITIONS | NOTES | TEMPERATURE | LIMITS |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  | MIN | MAX |  |
| Slew Rate | +SR | $\mathrm{V}_{\text {OUT }}=-5 \mathrm{~V}$ to $+5 \mathrm{~V}, \mathrm{~V}_{\mathrm{X}}=2 \mathrm{~V}_{\text {DC }}$ | 1 | $+25^{\circ} \mathrm{C}$ | 300 | - | V/us |
|  |  |  | 1 | $+125^{\circ} \mathrm{C},-55^{\circ} \mathrm{C}$ | 300 | - | V/us |
|  | -SR | $\mathrm{V}_{\text {OUT }}=+5 \mathrm{~V}$ to $-5 \mathrm{~V}, \mathrm{~V}_{\mathrm{X}}=2 \mathrm{~V}_{\mathrm{DC}}$ | 1 | $+25^{\circ} \mathrm{C}$ | 300 | - | V/us |
|  |  |  | 1 | $+125^{\circ} \mathrm{C},-55^{\circ} \mathrm{C}$ | 300 | - | V/us |
| Rise and Fall Time | TR | $\begin{aligned} & V_{\text {OUT }}=-100 \mathrm{mV} \text { to }+100 \mathrm{mV} \\ & V_{X}=2 V_{\text {DC }} \end{aligned}$ | 1,3 | $+25^{\circ} \mathrm{C}$ | - | 15 | ns |
|  |  |  | 1,3 | $+125^{\circ} \mathrm{C},-55^{\circ} \mathrm{C}$ | - | 17 | ns |
|  | TF | $\begin{aligned} & \mathrm{V}_{\text {OUT }}=+100 \mathrm{mV} \text { to }-100 \mathrm{mV} \\ & \mathrm{~V}_{\mathrm{X}}=2 \mathrm{~V}_{\mathrm{DC}} \end{aligned}$ | 1, 3 | $+25^{\circ} \mathrm{C}$ | - | 15 | ns |
|  |  |  | 1, 3 | $+125^{\circ} \mathrm{C},-55^{\circ} \mathrm{C}$ | - | 17 | ns |
| Overshoot | +OS | $\begin{aligned} & V_{\text {OUT }}=-100 \mathrm{mV} \text { to }+100 \mathrm{mV} \\ & \mathrm{~V}_{\mathrm{X}}=2 \mathrm{~V}_{\mathrm{DC}} \end{aligned}$ | 1 | $+25^{\circ} \mathrm{C}$ | - | 30 | \% |
|  |  |  | 1 | $+125^{\circ} \mathrm{C},-55^{\circ} \mathrm{C}$ | - | 30 | \% |
|  | -OS | $\begin{aligned} & \mathrm{V}_{\text {OUT }}=+100 \mathrm{mV} \text { to }-100 \mathrm{mV} \\ & \mathrm{~V}_{\mathrm{X}}=2 \mathrm{~V}_{\mathrm{DC}} \end{aligned}$ | 1 | $+25^{\circ} \mathrm{C}$ | - | 30 | \% |
|  |  |  | 1 | $+125^{\circ} \mathrm{C},-55^{\circ} \mathrm{C}$ | - | 30 | \% |
| Full Power Bandwidth | FPBW | $\mathrm{V}_{\text {PEAK }}=5 \mathrm{~V}, \mathrm{~V}_{\mathrm{X}}=2 \mathrm{~V}_{\mathrm{DC}}$ | 1,2 | $+25^{\circ} \mathrm{C}$ | 9.5 | - | MHz |
|  |  |  | 1, 2 | $+125^{\circ} \mathrm{C},-55^{\circ} \mathrm{C}$ | 9.5 | - | MHz |

NOTES:

1. Parameters listed in Table 3 are controlled via design or process parameters and are not directly tested at final production. These parameters are lab characterized upon initial design release, or upon design changes. These parameters are guaranteed by characterization based upon data from multiple production runs which reflect lot to lot and within lot variation.
2. Full Power Bandwidth guarantee based on Slew Rate measurement using FPBW = Slew Rate/( $\left.2 \pi \mathrm{~V}_{\text {PEAK }}\right)$.
3. Measured between $10 \%$ and $90 \%$ points.

TABLE 4. ELECTRICAL TEST REQUIREMENTS

| MIL-STD-883 TEST REQUIREMENTS | SUBGROUPS (SEE TABLE 1) |
| :--- | :---: |
| Interim Electrical Parameters (Pre Burn-in) | 1 |
| Final Electrical Test Parameters | 1(Note 1), 2, 3 |
| Group A Test Requirements | $1,2,3$ |
| Groups C and D Endpoints | 1 |

NOTE:

1. PDA applies to Subgroup 1 only.

## Die Characteristics

## DIE DIMENSIONS:

79.9 mils $\times 119.7$ mils $\times 19$ mils $\pm 1$ mils

METALLIZATION:
Type: AI, 1\%Cu。
Thickness: 16k $\AA 2 k \AA$
GLASSIVATION:
Type: Nitride $\left(\mathrm{Si}_{3} \mathrm{~N}_{4}\right)$ over Silox $\left(\mathrm{SiO}_{2}, 5 \%\right.$ Phos)
Silox Thickness: $12 \mathrm{k} \AA \pm 1.5 \mathrm{k} \AA$
Nitride Thickness: $3.5 \mathrm{k} \AA \pm 1.5 \mathrm{k} \AA$
WORST CASE CURRENT DENSITY:
$0.72 \times 10^{5} \mathrm{~A} / \mathrm{cm}^{2}$
TRANSISTOR COUNT: 87
Metallization Mask Layout

HA-2546/883
$V_{\text {REF }}$ GND GAA GAC
(2) (1)
(16) (15)


## Test Circuit



For Detailed Information, Refer to HA-2546/883 Test Tech Brief

## Test Waveforms

## LARGE AND SMALL SIGNAL RESPONSE TEST CIRCUIT



Test Waveforms (Continued)
$V_{Y}$ LARGE SIGNAL RESPONSE
Vertical Scale: 5V/Div. Horizontal Scale: 50ns/Div.

$\mathrm{V}_{\mathrm{X}}$ LARGE SIGNAL RESPONSE
Vertical Scale: 2V/Div. Horizontal Scale: 50ns/Div.

$\mathrm{V}_{\mathrm{Y}}$ SMALL SIGNAL RESPONSE
Vertical Scale: 100 mV /Div. Horizontal Scale: $50 \mathrm{~ns} /$ Div.

$\mathrm{V}_{\mathrm{x}}$ SMALL SIGNAL RESPONSE
Vertical Scale: $200 \mathrm{mV} /$ Div. Horizontal Scale: $50 \mathrm{~ns} /$ Div.


## Burn-In Circuits



NOTES:
C1 $=0.01 \mu \mathrm{~F} /$ Socket Min.
C2 $=0.01 \mu \mathrm{~F} /$ Socket Min.
D1 = D2 $=$ IN4002 or Equivalent/Board
$|(\mathrm{V}+)-(\mathrm{V}-)|=31 \mathrm{~V} \pm 1 \mathrm{~V}$

## HA-2546/883 CERAMIC LCC



NOTES:
C1 $=$ C2 $=0.01 \mu \mathrm{~F} /$ Socket Min.
D1 = D2 $=$ IN4002 or Equivalent/Board
$|(\mathrm{V}+)-(\mathrm{V}-)|=31 \mathrm{~V} \pm 1 \mathrm{~V}$

## Simplified Schematic




## NOTES:

1. Index area: A notch or a pin one identification mark shall be located adjacent to pin one and shall be located within the shaded area shown. The manufacturer's identification shall not be used as a pin one identification mark.
2. The maximum limits of lead dimensions $b$ and $c$ or $M$ shall be measured at the centroid of the finished lead surfaces, when solder dip or tin plate lead finish is applied.
3. Dimensions b1 and c1 apply to lead base metal only. Dimension M applies to lead plating and finish thickness.
4. Corner leads ( $1, \mathrm{~N}, \mathrm{~N} / 2$, and $\mathrm{N} / 2+1$ ) may be configured with a partial lead paddle. For this configuration dimension b3 replaces dimension b1.
5. This dimension allows for off-center lid, meniscus, and glass overrun.
6. Dimension $Q$ shall be measured from the seating plane to the base plane.
7. Measure dimension S1 at all four corners.
8. N is the maximum number of terminal positions.
9. Dimensioning and tolerancing per ANSI Y14.5M - 1982.
10. Controlling Dimension: Inch.
11. Materials: Compliant to MIL-I-38535.

F16.3 MIL-STD-1835 GDIP1-T16 (D-2, CONFIGURATION A) 16 LEAD DUAL-IN-LINE FRIT-SEAL CERAMIC PACKAGE

| SYMBOL | INCHES |  | MILLIMETERS |  | NOTES |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | MIN | MAX | MIN | MAX |  |
| A | - | 0.200 | - | 5.08 | - |
| b | 0.014 | 0.026 | 0.36 | 0.66 | 2 |
| b1 | 0.014 | 0.023 | 0.36 | 0.58 | 3 |
| b2 | 0.045 | 0.065 | 1.14 | 1.65 | - |
| b3 | 0.023 | 0.045 | 0.58 | 1.14 | 4 |
| c | 0.008 | 0.018 | 0.20 | 0.46 | 2 |
| c1 | 0.008 | 0.015 | 0.20 | 0.38 | 3 |
| D | - | 0.840 | - | 21.34 | 5 |
| E | 0.220 | 0.310 | 5.59 | 7.87 | 5 |
| e |  | SC |  | BSC | - |
| eA |  | SC |  | BSC | - |
| eA/2 |  | SC |  | BSC | - |
| L | 0.125 | 0.200 | 3.18 | 5.08 | - |
| Q | 0.015 | 0.060 | 0.38 | 1.52 | 6 |
| S1 | 0.005 | - | 0.13 | - | 7 |
| S2 | 0.005 | - | 0.13 | - | - |
| $\alpha$ | $90^{\circ}$ | $105^{\circ}$ | $90^{\circ}$ | $105^{\circ}$ | - |
| aaa | - | 0.015 | - | 0.38 | - |
| bbb | - | 0.030 | - | 0.76 | - |
| ccc | - | 0.010 | - | 0.25 | - |
| M | - | 0.0015 | - | 0.038 | 2 |
| N | 16 |  | 16 |  | 8 |

## Packaging (Continued)



J20.A MIL-STD-1835 CQCC1-N20 (C-2)
20 PAD METAL SEAL LEADLESS CERAMIC CHIP CARRIER

| SYMBOL | INCHES |  | MILLIMETERS |  | NOTES |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | MIN | MAX | MIN | MAX |  |
| A | 0.060 | 0.100 | 1.52 | 2.54 | 6, 7 |
| A1 | 0.050 | 0.088 | 1.27 | 2.23 | 7 |
| B | - | - | - | - | 4 |
| B1 | 0.022 | 0.028 | 0.56 | 0.71 | 2, 4 |
| B2 | 0.072 REF |  | 1.83 REF |  | - |
| B3 | 0.006 | 0.022 | 0.15 | 0.56 | - |
| D | 0.342 | 0.358 | 8.69 | 9.09 | - |
| D1 | 0.200 BSC |  | 5.08 BSC |  | - |
| D2 | 0.100 BSC |  | 2.54 BSC |  | - |
| D3 | - | 0.358 | - | 9.09 | 2 |
| E | 0.342 | 0.358 | 8.69 | 9.09 | - |
| E1 | 0.200 BSC |  | 5.08 BSC |  | - |
| E2 | 0.100 BSC |  | 2.54 BSC |  | - |
| E3 | - | 0.358 | - | 9.09 | 2 |
| e | 0.050 BSC |  | 1.27 BSC |  | - |
| e1 | 0.015 | - | 0.38 | - | 2 |
| h | 0.040 REF |  | 1.02 REF |  | 5 |
| j | 0.020 REF |  | 0.51 REF |  | 5 |
| L | 0.045 | 0.055 | 1.14 | 1.40 | - |
| L1 | 0.045 | 0.055 | 1.14 | 1.40 | - |
| L2 | 0.075 | 0.095 | 1.91 | 2.41 | - |
| L3 | 0.003 | 0.015 | 0.08 | 0.38 | - |
| ND | 5 |  | 5 |  | 3 |
| NE | 5 |  | 5 |  | 3 |
| N | 20 |  | 20 |  | 3 |

NOTES:

1. Metallized castellations shall be connected to plane 1 terminals and extend toward plane 2 across at least two layers of ceramic or completely across all of the ceramic layers to make electrical connection with the optional plane 2 terminals.
2. Unless otherwise specified, a minimum clearance of 0.015 inch $(0.381 \mathrm{~mm})$ shall be maintained between all metallized features (e.g., lid, castellations, terminals, thermal pads, etc.)
3. Symbol " $N$ " is the maximum number of terminals. Symbols " $N D$ " and "NE" are the number of terminals along the sides of length "D" and "E", respectively.
4. The required plane 1 terminals and optional plane 2 terminals shall be electrically connected.
5. The corner shape (square, notch, radius, etc.) may vary at the manufacturer's option, from that shown on the drawing.
6. Chip carriers shall be constructed of a minimum of two ceramic layers.
7. Maximum limits allows for 0.007 inch solder thickness on pads.
8. Materials: Compliant to MIL-I-38535.

DESIGN INFORMATION
Wideband Two Quadrant Analog Multiplier

The information contained in this section has been developed through characterization by Intersil Semiconductor and is for use as application and design information only. No guarantee is implied.
Typical Performance Curves $\quad \mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, See Test Circuit For Multiplier Configuration.


## DESIGN INFORMATION (continued)

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Typical Performance Curves $\quad \mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, See Test Circuit For Multiplier Configuration. (Continued)



OFFSET VOLTAGE vs TEMPERATURE




## DESIGN INFORMATION (continued)

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Typical Performance Curves $\quad \mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, See Test Circuit For Multiplier Configuration. (Continued)
$\mathrm{V}_{\mathrm{x}}$ COMMON MODE REJECTION RATIO vs FREQUENCY


SUPPLY CURRENT vs TEMPERATURE


PSRR vs TEMPERATURE


PSRR vs FREQUENCY



MULTIPLIER ERROR


## DESIGN INFORMATION (continued)

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Typical Performance Curves $\quad \mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, See Test Circuit For Multiplier Configuration. (Continued)


MULTIPLIER ERROR


MULTIPLICATION ERROR vs TEMPERATURE


MULTIPLIER ERROR


WORST CASE MULTIPLICATION ERROR vs TEMPERATURE


GAIN VARIATION vs FREQUENCY


## DESIGN INFORMATION (continued)

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Typical Performance Curves $\quad \mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, See Test Circuit For Multiplier Configuration. (Continued)

SCALE FACTOR vs TEMPERATURE


SLEW RATE vs TEMPERATURE


OUTPUT VOLTAGE SWING vs LOAD RESISTANCE


RISE TIME vs TEMPERATURE


SUPPLY CURRENT vs SUPPLY VOLTAGE


## DESIGN INFORMATION (Continued)

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## Application Information

## Theory of Operation

The HA-2546 is a two quadrant multiplier with the following three differential inputs; the signal channel, $\mathrm{V}_{\mathrm{Y}^{+}}$and $\mathrm{V}_{\mathrm{Y}^{-}}$, the control channel, $\mathrm{V}_{\mathrm{X}}+$ and $\mathrm{V}_{\mathrm{X}^{-}}$, and the summed channel, $\mathrm{V}_{\mathrm{Z}^{+}}$and $\mathrm{V}_{\mathrm{Z}^{-}}$, to complete the feedback of the output amplifier. The differential voltages of channel X and Y are converted to differential currents. These currents are then multiplied in a circuit similar to a Gilbert Cell multiplier, producing a differential current product. The differential voltage of the $Z$ channel is converted into a differential current which then sums with the products currents. The differential "product/sum" currents are converted to a single-ended current and then converted to a voltage output by a transimpedance amplifier.

The open loop transfer equation for the HA-2546 is:
$\mathrm{V}_{\text {OUT }}=\mathrm{A}\left[\frac{\left(\mathrm{V}_{\mathrm{X}_{+}}-\mathrm{V}_{\mathrm{X}-}\right)\left(\mathrm{V}_{\mathrm{Y}_{+}}-\mathrm{V}_{\mathrm{Y}_{-}}\right)}{\mathrm{SF}}-\left(\mathrm{V}_{\mathrm{Z}_{+}}-\mathrm{V}_{\left.\mathrm{Z}_{-}\right)}\right]\right.$
where;

$$
\begin{aligned}
& A=\text { Output Amplifier Open Loop Gain } \\
& S F=\text { Scale Factor } \\
& V_{X}, V_{Y}, V_{Z}=\text { Differential Inputs }
\end{aligned}
$$

The scale factor is used to maintain the output of the multiplier within the normal operating range of $\pm 5 \mathrm{~V}$. The scale factor can be defined by the user by way of an optional external resistor, $\mathrm{R}_{\text {EXT }}$, and the Gain Adjust pins, Gain Adjust A (GA A), Gain Adjust B (GA B), and Gain Adjust C (GA C). The scale factor is determined as follows:

$$
\begin{aligned}
S F= & 2, \text { when } G A B \text { is shorted to } G A C \\
S F \cong & 1.2 R_{E X T}, \text { when } R_{E X T} \text { is connected between } \\
& G A A \text { and } G A C\left(R_{E X T} \text { is in } k \Omega\right) \\
S F \cong & 1.2\left(R_{E X T}+1.667 k \Omega\right) \text {, when } R_{E X T} \text { is } \\
& \text { connected to } G A B \text { and } G A C\left(R_{E X T} \text { is in } k \Omega\right)
\end{aligned}
$$

The scale factor can be adjusted from 2 to 5 . It should be noted that any adjustments to the scale factor will affect the AC performance of the control channel, $\mathrm{V}_{\mathrm{X}}$. The normal input operating range of $\mathrm{V}_{\mathrm{X}}$ is equal to the scale factor voltage.

The typical multiplier configuration is shown in Figure 1. The ideal transfer function for this configuration is:

$$
\mathrm{V}_{\mathrm{OUT}}=\left\{\begin{array}{cc}
\frac{\left(\mathrm{V}_{\mathrm{X}_{+}}-\mathrm{V}_{\mathrm{X}}\right)\left(\mathrm{V}_{\mathrm{Y}_{+}}-\mathrm{V}_{\mathrm{Y}_{-}}\right)}{2}+\mathrm{V}_{\mathrm{Z}_{-}}, & \text {when } \mathrm{V}_{\mathrm{X}} \geq 0 \mathrm{~V} \\
0 & \text { when } \mathrm{V}_{\mathrm{X}}<0 \mathrm{~V}
\end{array}\right.
$$



FIGURE 1.
The $\mathrm{V}_{\mathrm{X}-}$ pin is usually connected to ground so that when $\mathrm{V}_{\mathrm{X}_{+}}$ is negative there is no signal at the output, i.e. two quadrant operation. If the $\mathrm{V}_{\mathrm{X}}$ input is a negative going signal the $\mathrm{V}_{\mathrm{X}_{+}}$ pin maybe grounded and the $\mathrm{V}_{\mathrm{X}}$. pin used as the control input.

The $\mathrm{V}_{\mathrm{Y}_{-}}$terminal is usually grounded allowing the $\mathrm{V}_{\mathrm{Y}_{+}}$to swing $\pm 5 \mathrm{~V}$. The $\mathrm{V}_{\mathrm{Z}_{+}}$terminal is usually connected directly to $\mathrm{V}_{\text {OUT }}$ to complete the feedback loop of the output amplifier while $\mathrm{V}_{\mathrm{Z}}$ - is grounded. The scale factor is normally set to 2 by connecting GA B to GA C . Therefore the transfer equation simplifies to $\mathrm{V}_{\mathrm{OUT}}=\left(\mathrm{V}_{\mathrm{X}} \mathrm{V}_{\mathrm{Y}}\right) / 2$.

## Offset Adjustment

The signal channel offset voltage may be nulled by using a $20 \mathrm{k} \Omega$ potentiometer between $\mathrm{V}_{\mathrm{YIO}}$ Adjust pins A and B and connecting the wiper to -V . Reducing the signal channel offset will reduce $\mathrm{V}_{\mathrm{X}} \mathrm{AC}$ feedthrough. Output offset voltage can also be nulled by connecting $\mathrm{V}_{\mathrm{Z}}$ - to the wiper of a $20 \mathrm{k} \Omega$ potentiometer which is tied between +V and -V .

## Capacitive Drive Capability

When driving capacitive loads $>20 \mathrm{pF}$, a $50 \Omega$ resistor is recommended between $\mathrm{V}_{\text {OUT }}$ and $\mathrm{V}_{\mathrm{Z}_{+}}$, using $\mathrm{V}_{\mathrm{Z}_{+}}$as the output (See Figure 1). This will prevent the multiplier from going unstable.

## Power Supply Decoupling

Power supply decoupling is essential for high frequency circuits. A $0.01 \mu \mathrm{~F}$ high quality ceramic capacitor at each supply pin in parallel with a $1 \mu \mathrm{~F}$ tantalum capacitor will provide excellent decoupling. Chip capacitors produce the best results due to the close spacing with which they may be placed to the supply pins minimizing lead inductance.

## Adjusting Scale Factor

The HA-2546 two quadrant multiplier may be configured for many uses. Following are examples of a few typical applications.

## DESIGN INFORMATION (Continued)

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Adjusting the scale factor will tailor the control signal, $\mathrm{V}_{\mathrm{X}}$, input voltage range to match your needs. Referring to the simplified schematic and looking for the $V_{X}$ input stage, you will notice the unusual design. The internal reference sets up a 1.2 mA current sink for the $\mathrm{V}_{\mathrm{X}}$ differential pair. The control signal applied to this input will be forced across the scale factor setting resistor and set the current flowing in the $\mathrm{V}_{\mathrm{X}_{+}}$ side of the differential pair. When the current through this resistor reaches 1.2 mA , all the current available is flowing in the one side and full scale has been reached. Normally the $1.67 \mathrm{k} \Omega$ internal resistor sets the scale factor to 2 V when the Gain Adjust pins $B$ and $C$ are connected together, but you may set this resistor to any convenient value using pins 16 (GA A) and 15 (GA C).


FIGURE 2A. MULTIPLIER, $\mathrm{V}_{\text {OUT }}=\mathrm{V}_{\mathrm{X}} \mathrm{V}_{\mathbf{Y}} / 2$, SCALE FACTOR $=2 \mathrm{~V}$


FIGURE 2B. MULTIPLIER, $\mathrm{V}_{\text {OUT }}=\mathrm{V}_{\mathrm{X}} \mathrm{V}_{\mathrm{Y}} / 5$, SCALE FACTOR $=5 \mathrm{~V}$


FIGURE 3. AUTOMATIC GAIN CONTROL
In Figure 3, the HA-2546 is configured in a true Automatic Gain Control or AGC application. The HA-5127, low noise op amp, provides the gain control level to the X input. This level will set the peak output voltage of the multiplier to match the reference level. The feedback network around the HA-5127 provides stability and a response time adjustment for the gain control circuit.

## DESIGN INFORMATION (Continued)

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This multiplier has the advantage over other AGC circuits, in that the signal bandwidth is not affected by the control signal gain adjustment.

A wide range of gain adjustment is available with the Voltage Controlled Amplifier configuration shown in Figure 4A. and Figure 4B. Here the gain of the HFA0002 is swept from 20V/ V at a control voltage of 0.902 V to a gain of almost $1000 \mathrm{~V} / \mathrm{V}$ with a control voltage of 0.03 V .

The Video Fader circuit provides a unique function as shown in Figure 5. Here $C h B$ is applied to the minus $Z$ input in addition to the minus Y input. $\mathrm{V}_{\mathrm{MIX}}$ will control the percentage of Ch A and Ch B that are mixed together to produce a resulting video image or other signal.

Many other applications are possible including division, squaring, square-root, percentage calculations, etc. Please refer to the HA-2556 four quadrant multiplier for additional applications.


FIGURE 4B. VOLTAGE CONTROLLED AMPLIFIER


$$
\begin{aligned}
& \mathrm{V}_{\text {OUT }}=\mathrm{Ch} \mathrm{~B}+(\text { Ch } \mathrm{A}-\text { Ch } \mathrm{B}) \mathrm{V}_{\mathrm{MIX}} / \text { Scale Factor } \\
& \text { Scale Factor }=2 \\
& \mathrm{~V}_{\text {OUT }}=\text { All Ch } \mathrm{B} \text {; if } \mathrm{V}_{\mathrm{MIX}}=0 \mathrm{~V} \\
& \mathrm{~V}_{\text {OUT }}=\text { All Ch } \mathrm{A} \text {; if } \mathrm{V}_{\mathrm{MIX}}=2 \mathrm{~V} \text { (Full Scale) } \\
& \mathrm{V}_{\text {OUT }}=\text { Mix of Ch } \mathrm{A} \text { and Ch } \mathrm{B} \text {; if } \mathrm{OV}<\mathrm{V}_{\mathrm{MIX}}<2 \mathrm{~V}
\end{aligned}
$$

FIGURE 5. VIDEO FADER

## HA2546

## DESIGN INFORMATION (continued)

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## TYPICAL PERFORMANCE CHARACTERISTICS

Device Tested at: Supply Voltage $= \pm 15 \mathrm{~V}, \mathrm{R}_{\text {LOAD }}=1 \mathrm{k} \Omega, \mathrm{C}_{\text {LOAD }}=50 \mathrm{pF}$, Unless Otherwise Specified.


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